

Advances in μ -RWELL technology

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OUTLINE

- ❑ Introduction
- ❑ The μ -RWELL technology
- ❑ Detector performance
- ❑ Towards a large area μ -RWELL
- ❑ Summary

Introduction

MicroPattern Gas Detectors (MPGD) due to their performance are ideal tools for :

- **fundamental research** (*Compass, LHCb, Totem, KLOE, Jlab, LHC experiments upgrades*)
- **applications beyond science** (*medical, industrial, neutron ...*)

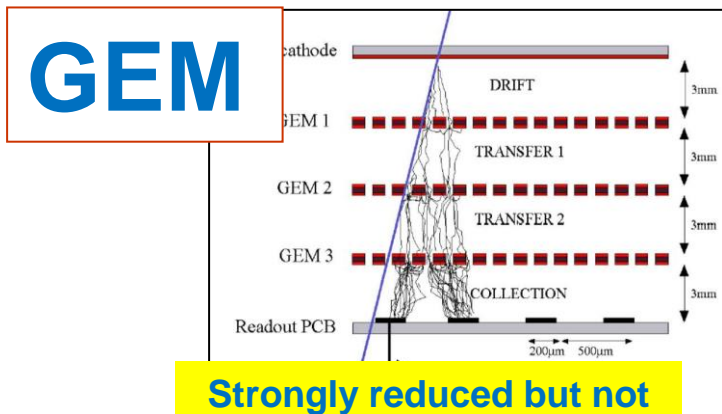
In spite of the recent relevant progress in the field, **still dedicated R&D studies are required** for:

- **stability under heavy irradiation** (discharge containment)
- **simplified construction technologies**, a MUST for
 - very large scale applications in fundamental research
 - technology dissemination beyond HEP

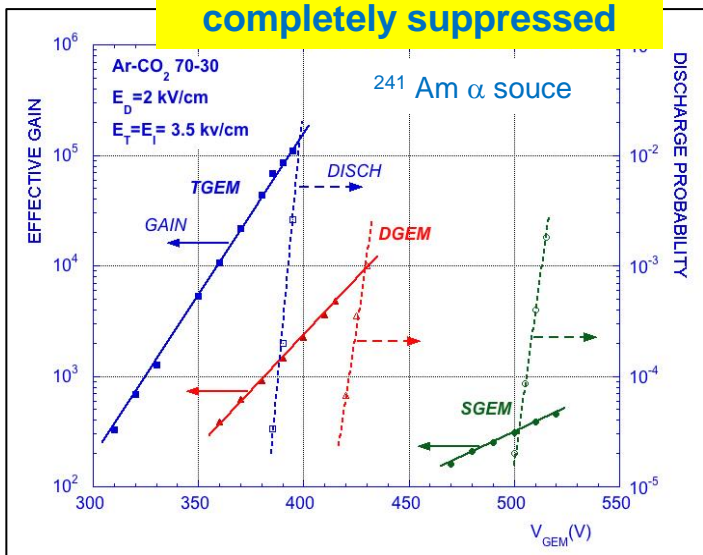
MPGDs: stability

The **biggest “enemy”** of MPGDs are the **discharges**.

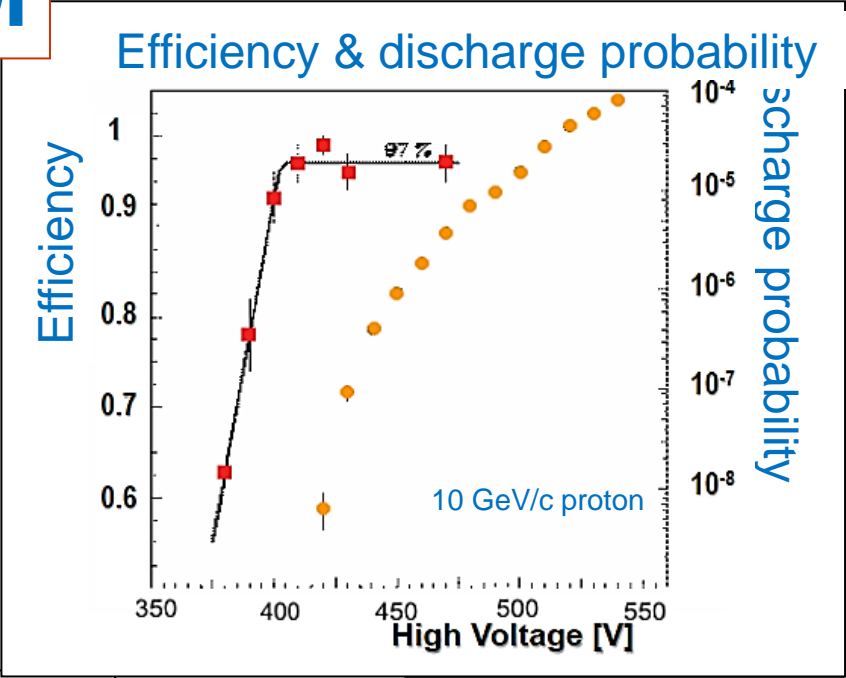
Due to the **fine structure** and the **typical micrometric distance** of their electrodes, MPGDs generally suffer from **spark occurrence** that can be **harmful for the detector and the related FEE**.



Strongly reduced but not completely suppressed



MM

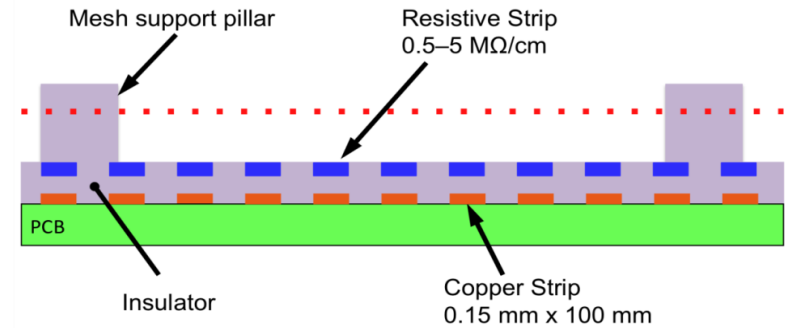


S. Bachmann et al., NIMA A479(2002) 294

A. Bay et al., NIMA 488 (2002) 162

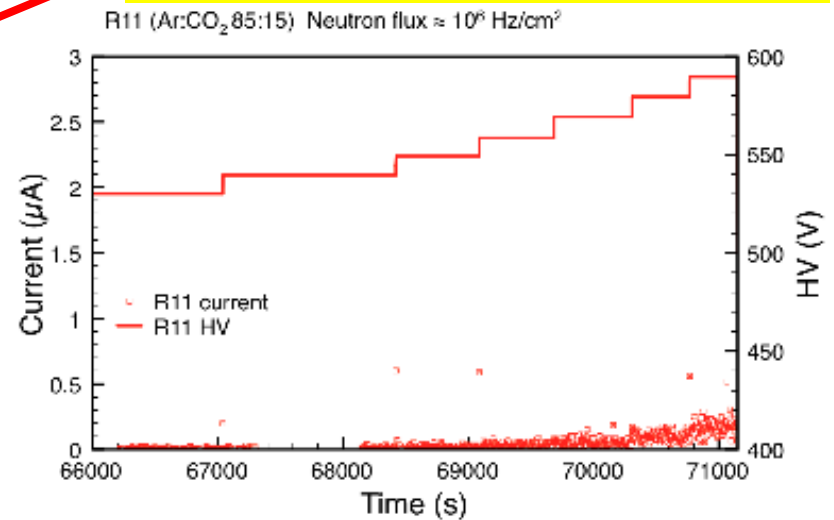
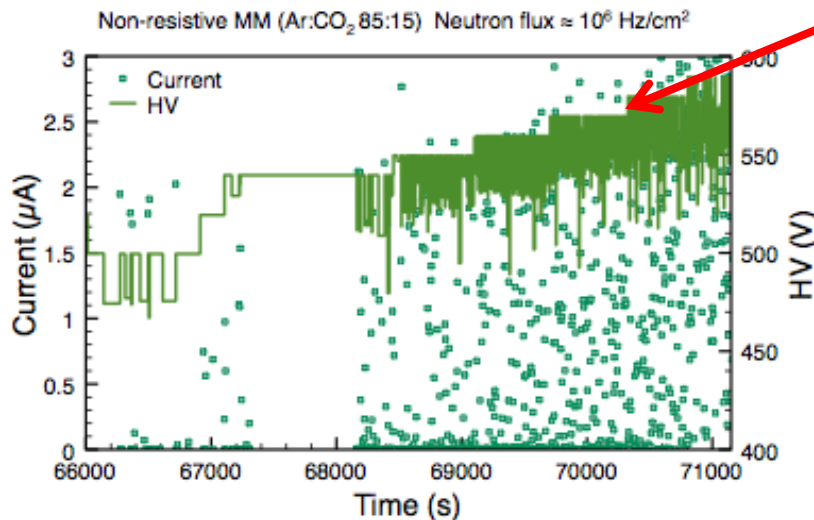
Technology improvement: resistive MPGD

For **MM**, the spark occurrence between the metallic mesh and the readout PCB has been overcome with the **implementation** of a **“resistive layer”** on top of the readout itself. The principle is the same as the **resistive electrode used in the RPCs: the transition from streamer to spark is strongly suppressed by a local voltage drop.**



by R.de Oliveira TE MPE CERN Workshop

The resistive layer is realized as resistive strips capacitively coupled with the copper readout strips.



MPGDs: the challenge of large area

A further **challenge for MPGDs**, especially in view of their applications in the large HEP experiments, is the **large area**:

- the construction of a **GEM** requires some time-consuming (/complex) assembly steps such as:
 - the **stretching of the 3 GEM foils** (with quite **large mechanical tension** to cope with, ~ 1 kg/cm)
 - the **splicing of GEM foils** to realize large surfaces is a **demanding operation** introducing **not negligible dead zones** (~ 3 mm). The width of the **raw material is limited to 50-60 cm**.
 - similar considerations hold for **MM**:
 - ✓ the **splicing of smaller PCBs is possible**, opening the way towards the large area covering (**dead zone of the order 0.3 mm**).
 - The **fine metallic mesh**, defining the amplification gap, is a *“floating component”*: stretched on the cathode (~ 1 kg/cm) and **electrostatically attracted toward the PCB**
- ➔ Possible source of gain non-uniformity**

NS2(CERN): no gluing but still stretching ...



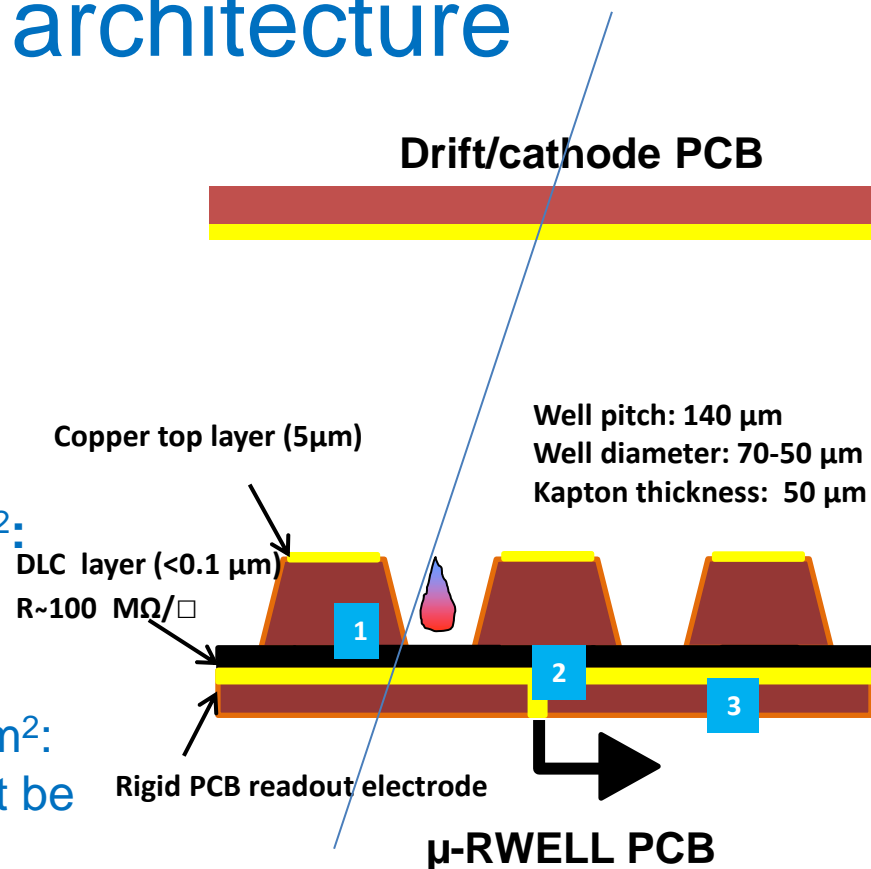
Handling of a stretched mesh



The μ -RWELL architecture

The μ -RWELL_PCB is realized by **coupling**:

1. a “**suitable WELL patterned kapton foil** as “amplification stage”
2. a “**resistive stage**” for the discharge suppression & current evacuation
 - i. “**Low particle rate**” (LR) $\ll 100$ kHz/cm²:
single resistive layer \rightarrow surface resistivity ~ 100 M Ω / \square (CMS-phase2 upgrade)
 - ii. “**High particle rate**” (HR) $\gg 100$ kHz/cm²:
more sophisticated resistive scheme must be implemented (MPDG_NEXT- LNF)



3. a **standard readout PCB**

G. Bencivenni et al., 2015_JINST_10_P02008

The μ -RWELL is a compact & simple to build:

- only two mechanical components: μ -RWELL_PCB + cathode
- no critical & time consuming assembly steps:
 - no gluing, no stretching, easy handling
- no stiff & large frames
- large area with PCB splicing technique (more simple than GEM and MM)

LR scheme: single resistive layer

HR scheme: double resistive layers

DLC-coated kapton base material: DLC layer $< 0.1 \mu\text{m}$ ($100 \text{ M}\Omega/\square$)

1

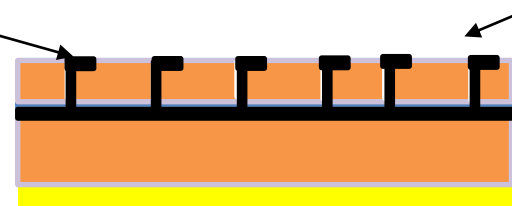


Kapton layer $50 \mu\text{m}$

Copper layer $5 \mu\text{m}$



Kapton layer ($12\text{-}25 \mu\text{m}$) with $1/\text{cm}^2$ vias density .
Screen printed with a "buried-resistances" pattern



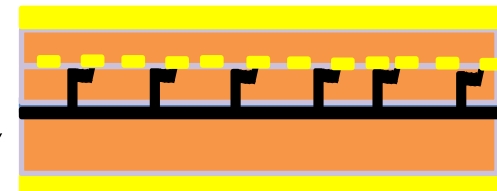
2



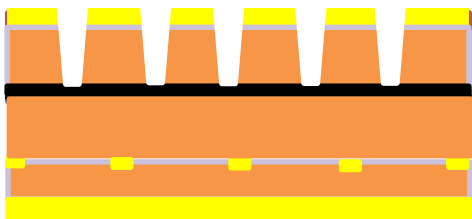
Strip kapton layer ($50 \mu\text{m}$)

pre-preg ($50\text{-}75 \mu\text{m}$)

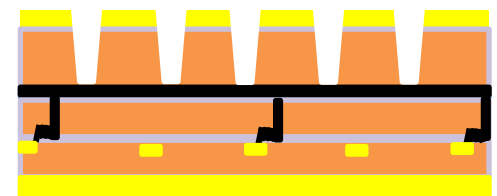
DLC-coated kapton base material



3



DLC-coated base material after copper and kapton chemical etching



The μ -RWELL: a GEM-MM mixed solution

The μ -RWELL has features in common either with **GEMs** or **MMs**:

- **MMs** are realized on **rigid** substrate
- **GEM** on **flex** substrate
- μ -RWELL exploits both technologies, **rigid and flexible** (but also **full-flex**)

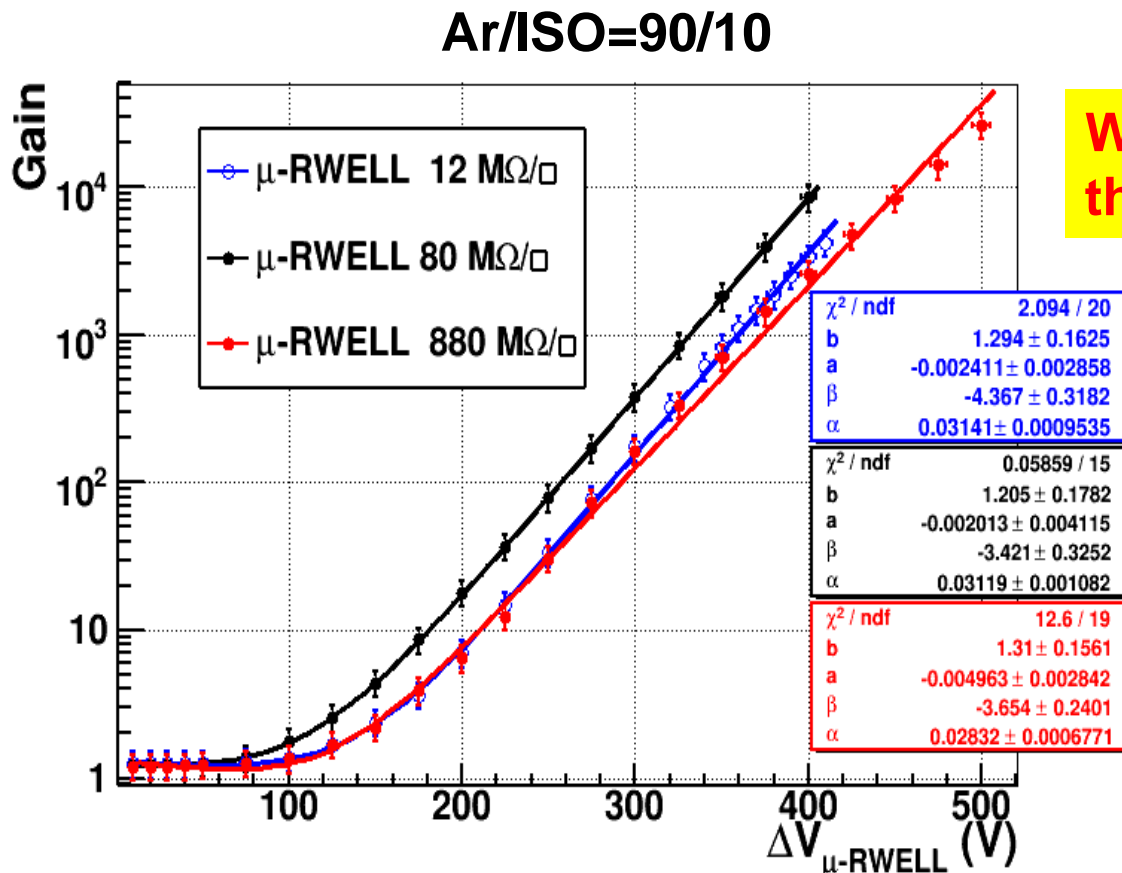
The μ -RWELL :

- inherits and improves the **GEM amplifying scheme** with the peculiarity of a “**well defined amplifying gap**”, but ensuring **higher and more uniform gas gain**, with no transfer/induction gaps whose non-uniformity can affect the detector gain
- inherits the **MM resistive readout scheme** that allows a “**strong suppression**” of the amplitude of the **discharges**.

The μ -RWELL performance: Lab Test

μ -RWELL: gas gain

The prototypes have been tested with an X-Ray gun (5,9 keV) with $\text{Ar}/\text{CO}_2 = 70/30$, $\text{Ar}/i\text{-C}_4\text{H}_{10} = 90/10$ gas mixtures and characterized by measuring the gas gain, rate capability and studying the discharge behaviour in current mode.

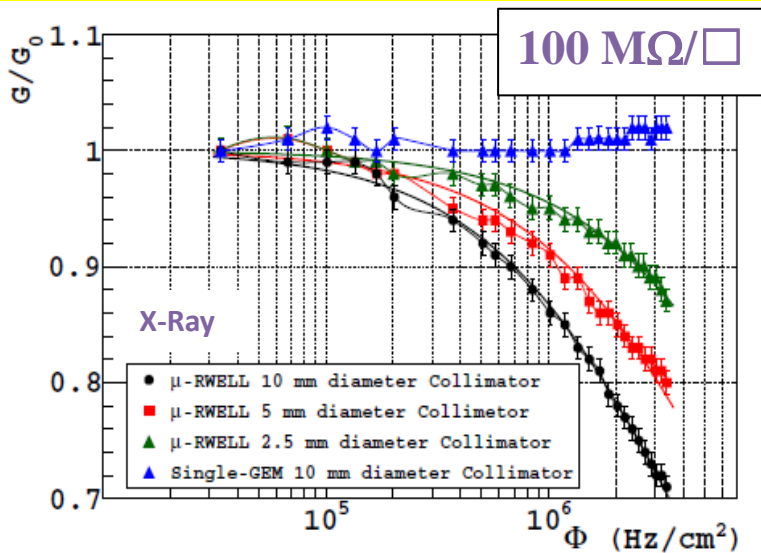


WELL kapton thickness = 50 μm

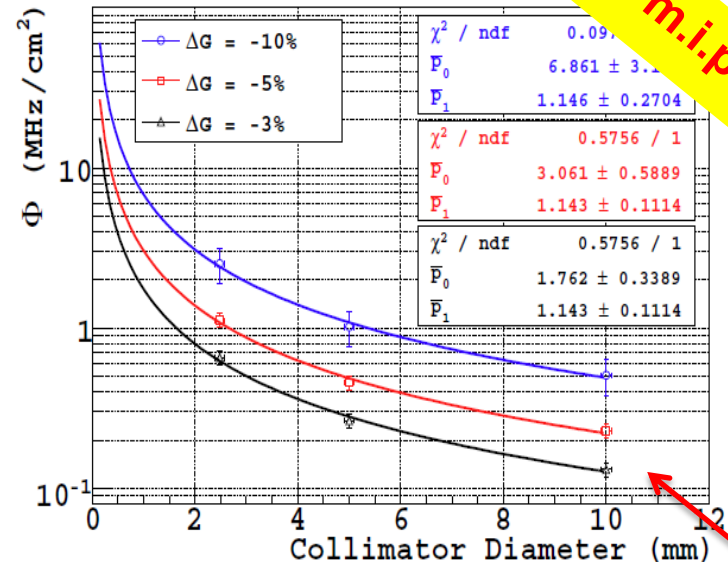
μ -RWELL: rate capability(I)

A drawback correlated with the implementation of a resistive layer is the reduced capability to stand high particle fluxes

Ar/CO₂ – $G_{\mu\text{-RWELL}} = 2000$, $G_{\text{GEM}} \sim 1000$



collimator aligned with the center of the detector



150-200 kHz/cm² with X-Rays
corresponding to 1 – 1.5 MHz/cm² m.i.p.

for m.i.p. X 7

Taking into account that:

- the ionization of a m.i.p. is a factor 7 smaller than X-rays
- the resistive stage can be suitably segmented in order to evacuate the current every $\sim 1 \times 1 \text{ cm}^2$ (a sort of “matrix of resistive pads put at ground” \rightarrow HR scheme)
a rate of $\sim 1 \text{ MHz/cm}^2$ for m.i.p. should be easily achieved (tbd)

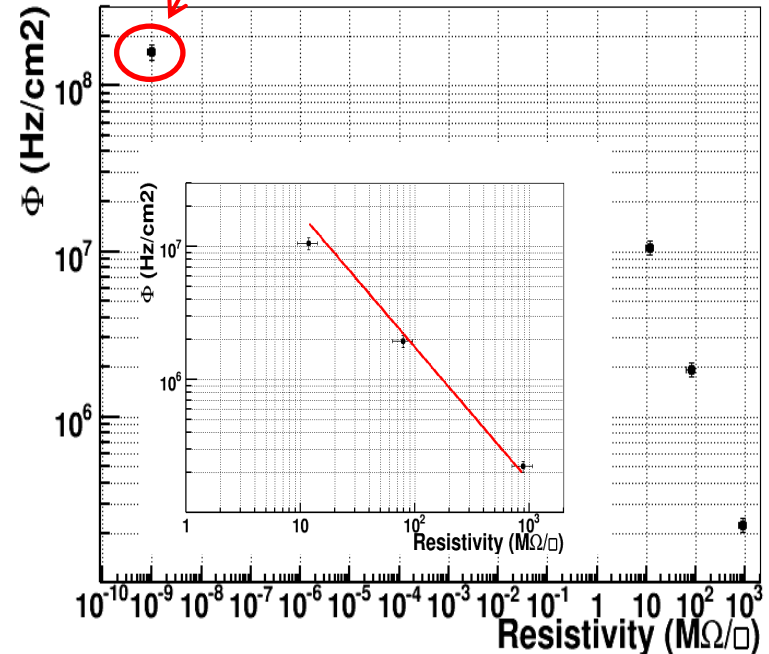
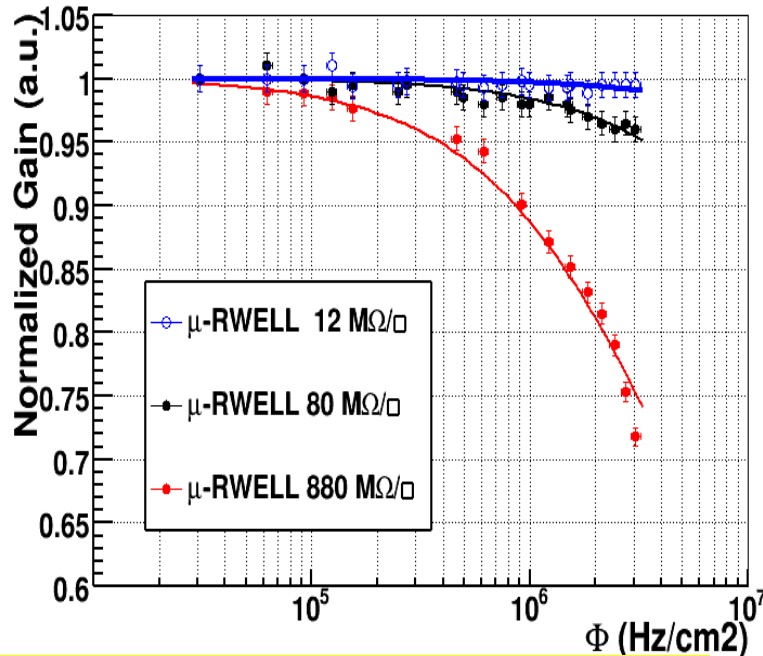
μ-RWELL: rate capability(II) vs layer resistivity

Bellazini et al. NIMA 423 (1999) 125
Sauli et al., NIMA 419 (1998) 410.

Ar/Iso - 2,5 mm Diameter Collimator

Gain = 1000

Rate for a drop ΔG=-3%



Model based on a pure Ohmic behaviour

$$\frac{G}{G_0} = \frac{-1 + \sqrt{1 + 4p_0\Phi}}{2p_0\Phi}$$

$$p_0 = \alpha e N_0 G_0 \Omega \pi r^2$$

Resistivity declared by the deliverer: 1 GOhm/square
Resistivity=883.782 MOhm/square +- 176.756

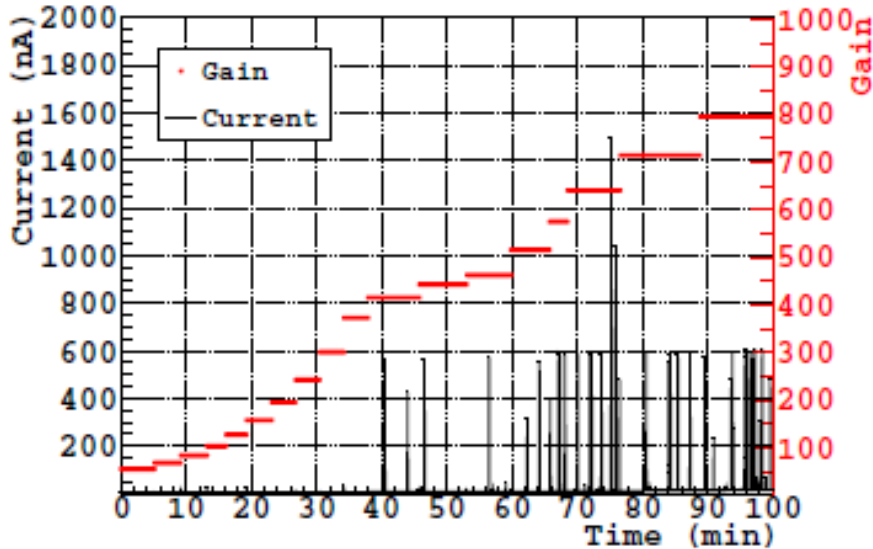
Resistivity declared by the deliverer: 80 MOhm/square
Resistivity=79.2628 MOhm/square +- 15.8526

Resistivity measured by us: 7.5 MOhm/square
Resistivity=11.7345 MOhm/square +- 2.3469

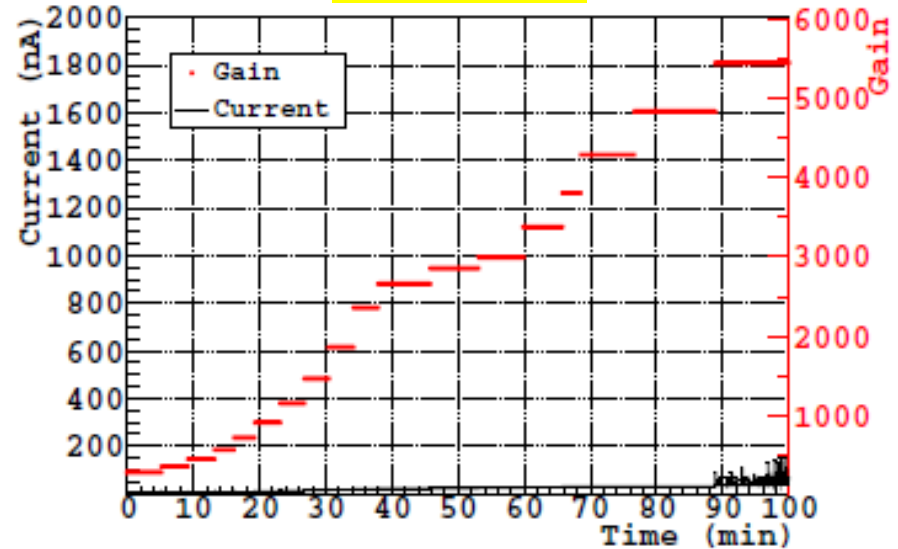
μ -RWELL: discharge study

Discharge study (qualitative): μ -RWELL vs GEM

Single-GEM



μ -RWELL



□ for μ -RWELL discharge amplitude of the order of **few tens of nA (<100 nA @ max gain)**

□ for **GEM** discharge amplitude of the order of **1 μ A**

More quantitative studies must be clearly performed

The μ -RWELL performance: Beam Tests



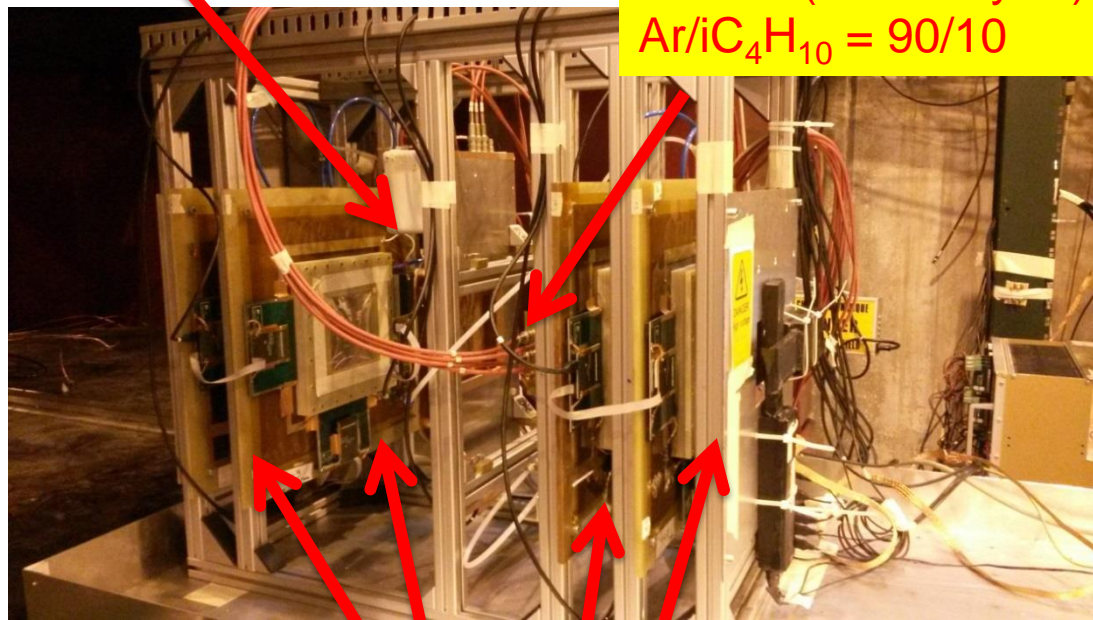
H4 Beam Area (RD51)

Muon beam momentum: 150 GeV/c

Goliath: B up to 1.4 T

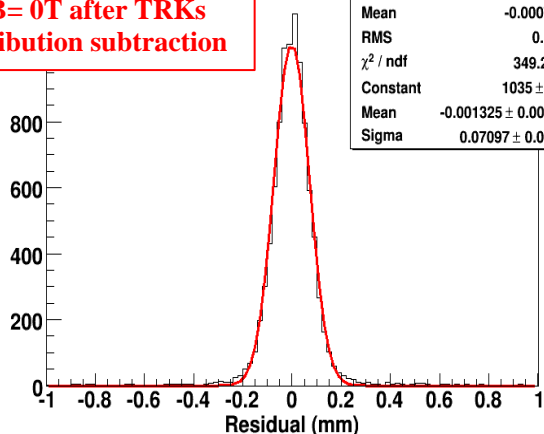
BES III-GEM chambers

μ -RWELL prototype
 12-80-880 M Ω / \square
 400 μ m pitch strips
 APV25 (CC analysis)
 Ar/iC₄H₁₀ = 90/10



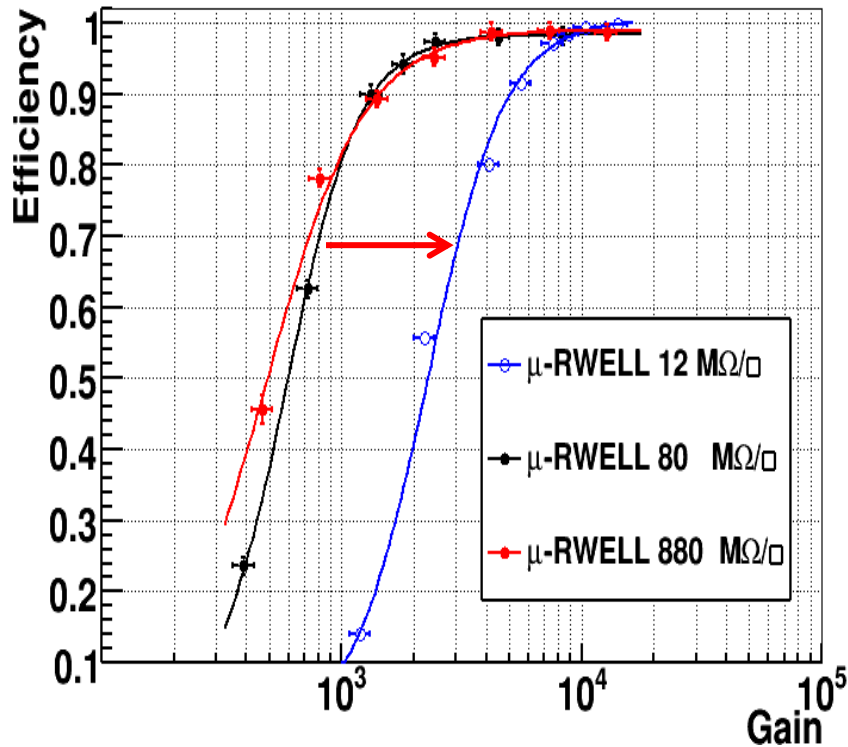
GEMs Trackers

$\sigma_{RWELL} = (52 \pm 6) \mu\text{m}$
 @ B=0T after TRKs
 contribution subtraction

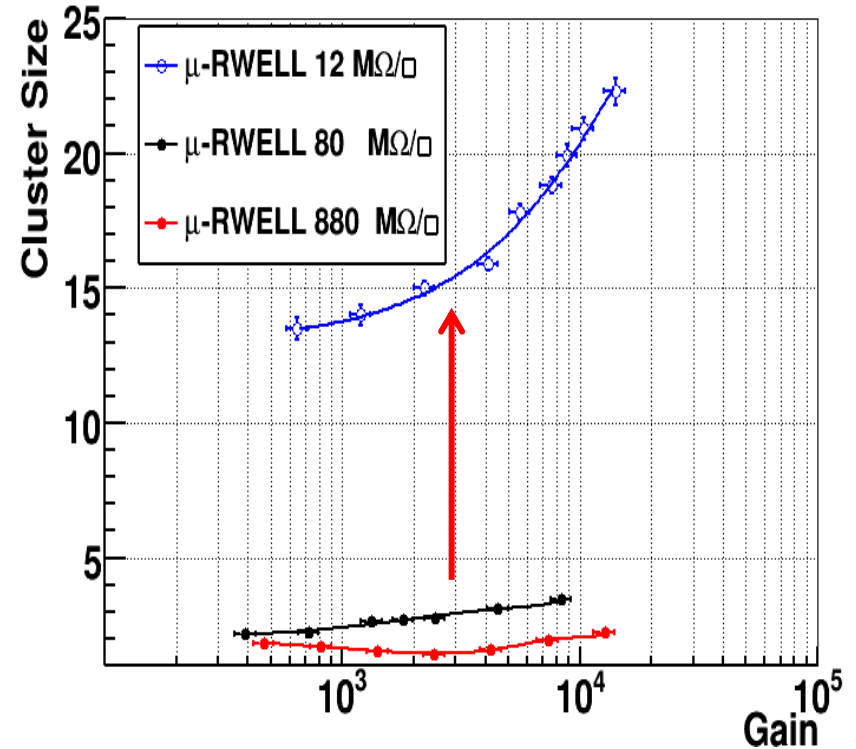


μ -RWELL: tracking efficiency

Ar/ISO=90/10



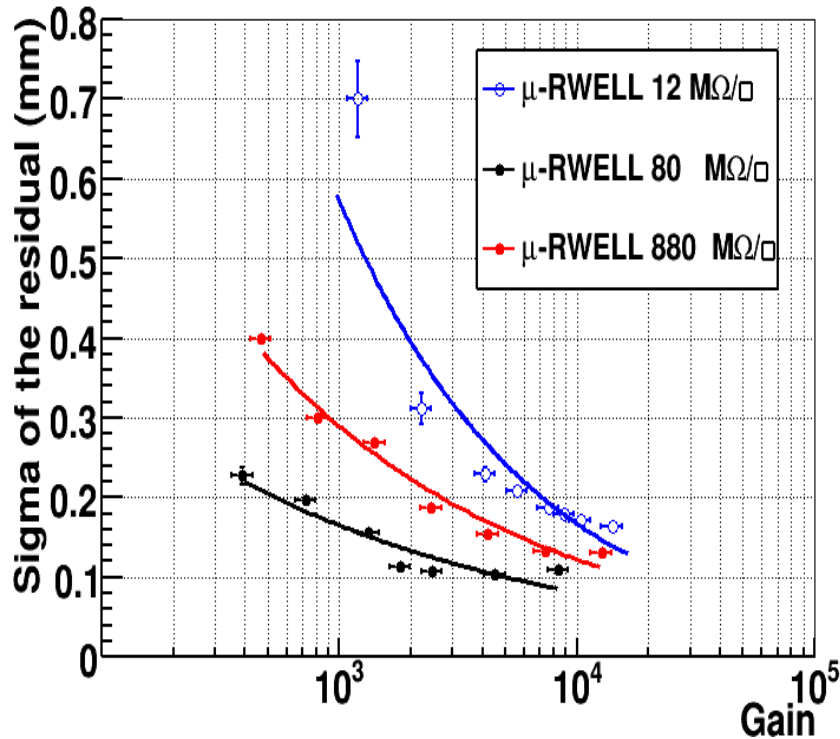
Ar/ISO=90/10



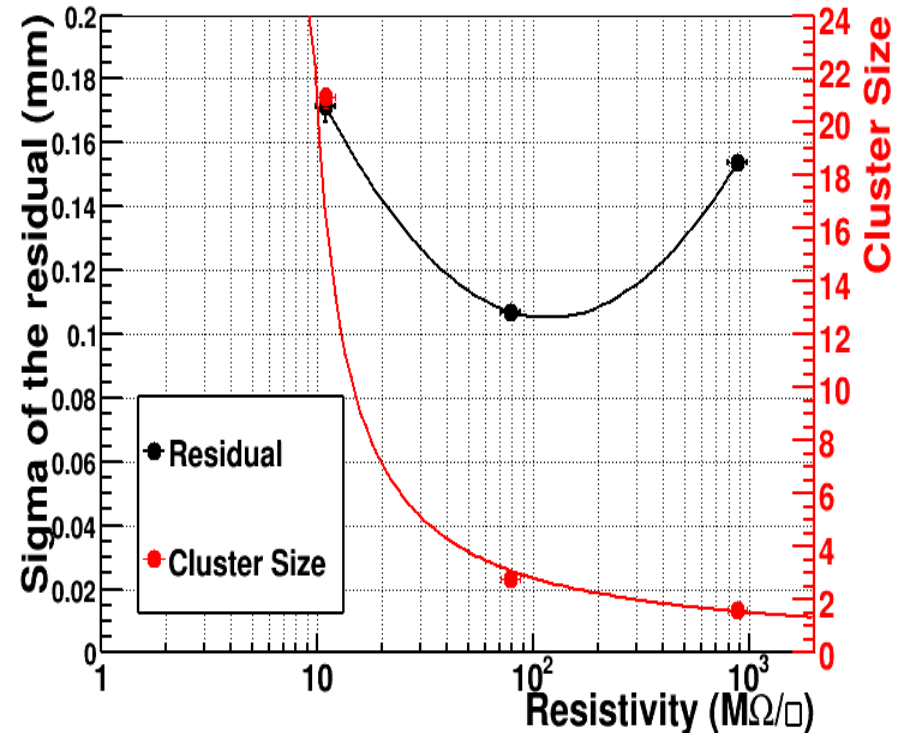
At low resistivity the spread of the charge (cluster size) on the readout strips increases, thus requiring a higher gain to reach the full detector efficiency.

Space resolution: orthogonal tracks

Ar/ISO=90/10



Ar/ISO=90/10



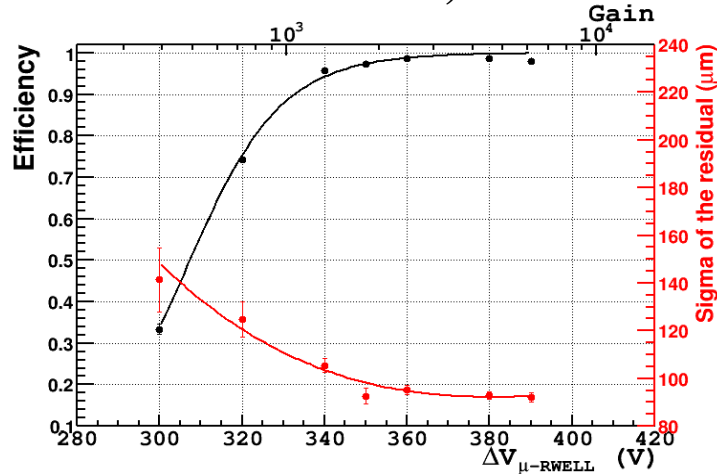
The **space resolution** exhibits a **minimum around 100M Ω/\square** .

At **low resistivity** the **charge spread increases** and then **σ is worsening**.

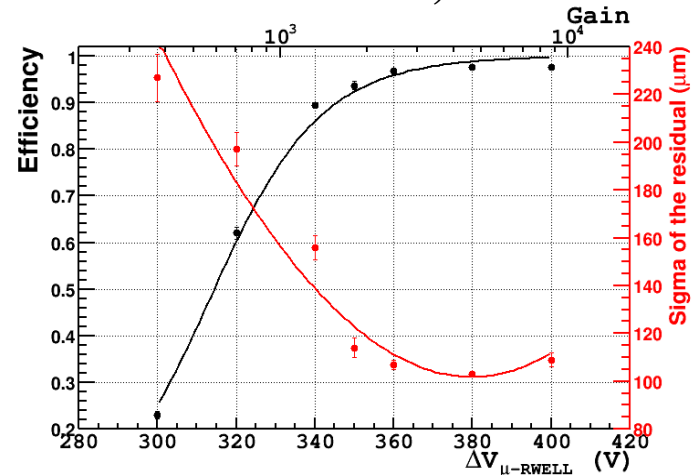
At **high resistivity** the **charge spread is too small** (**Cl_size \rightarrow 1**) then the Charge Centroid method becomes no more effective (**$\sigma \rightarrow$ pitch/ $\sqrt{12}$**).

μ -RWELL: $B \neq 0$ with Ar/ISO=90/10

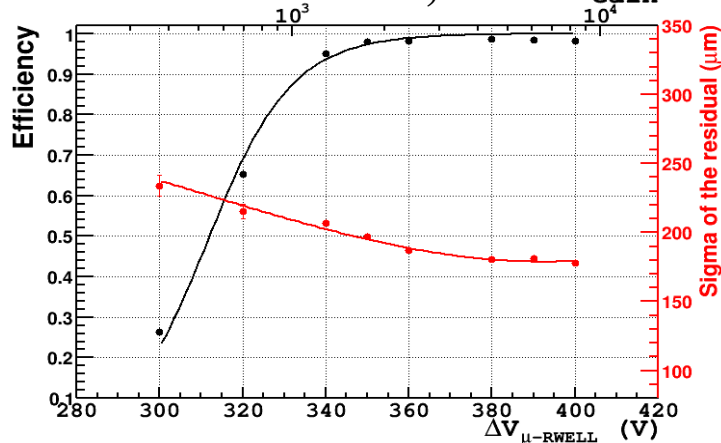
June 2015 – $\theta=0^\circ$, $B=0$ T



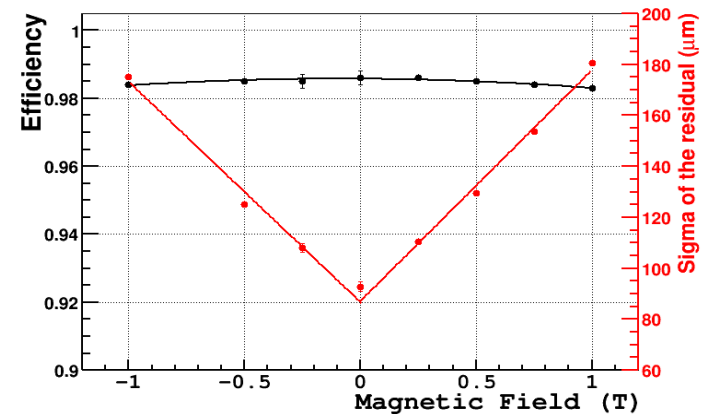
Dec 2014 – $\theta=0^\circ$, $B=0.5$ T



June 2015 – $\theta=0^\circ$, $B=1$ T



June 2015 - $\theta=0^\circ$



For $\theta=0^\circ$ and $0 < B < 1$ T \rightarrow $\sigma < 180 \mu\text{m}$ and $\epsilon > 98\%$

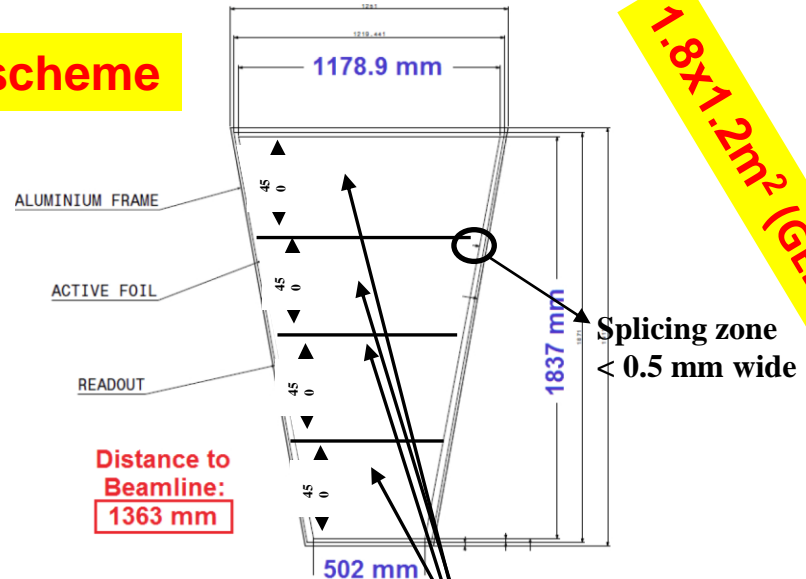
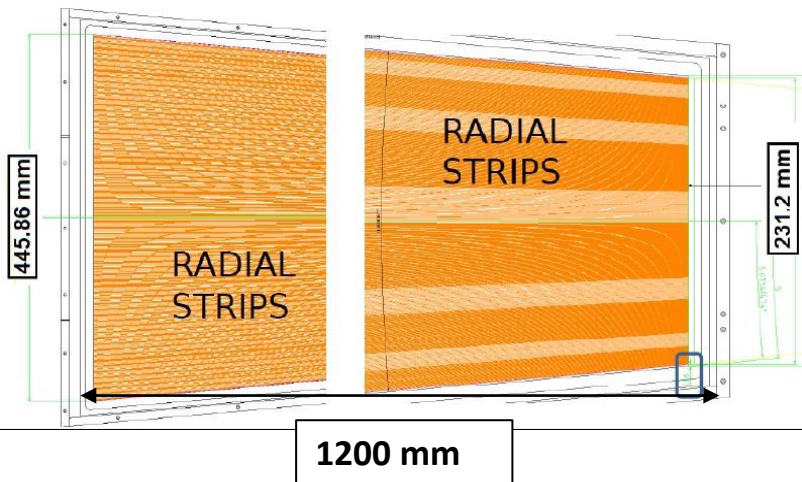
Towards large area & detector engineering

In the framework of the **CMS-phase2 muon upgrade** we are developing large size **μ -RWELL**. The **R&D** is performed in strict collaboration with an Italian industrial partner (**ELTOS SpA**). The work will be performed in **two years** with following schedule:

- | | | |
|------------------------------------|---|------------------|
| 1. Construction of the first | 1.2x0.5m² (GE1/1) μ-RWELL | (07/2016) |
| 2. Full characterization of the | 1.2x0.5m² (GE1/1) μ-RWELL | (12/2016) |
| 3. Mechanical study and mock-up of | 1.8x1.2 m² (GE2/1) μ-RWELL | (05/2017) |
| 4. Construction of the first | 1.8x1.2m² (GE2/1) μ-RWELL | (12/2017) |
| 5. Full characterization of the | 1.8x1.2m² (GE2/1) μ-RWELL | (06/2018) |

1.2x0.5m² (GE1/1) μ -RWELL

LR scheme



1.8x1.2m² (GE2/1) μ -RWELL

Four PCB μ -RWELL spliced with the same technique used for large ATLAS MM + only one cathode closing the detector

Summary

The μ -RWELL is the new frontier of MPGD:

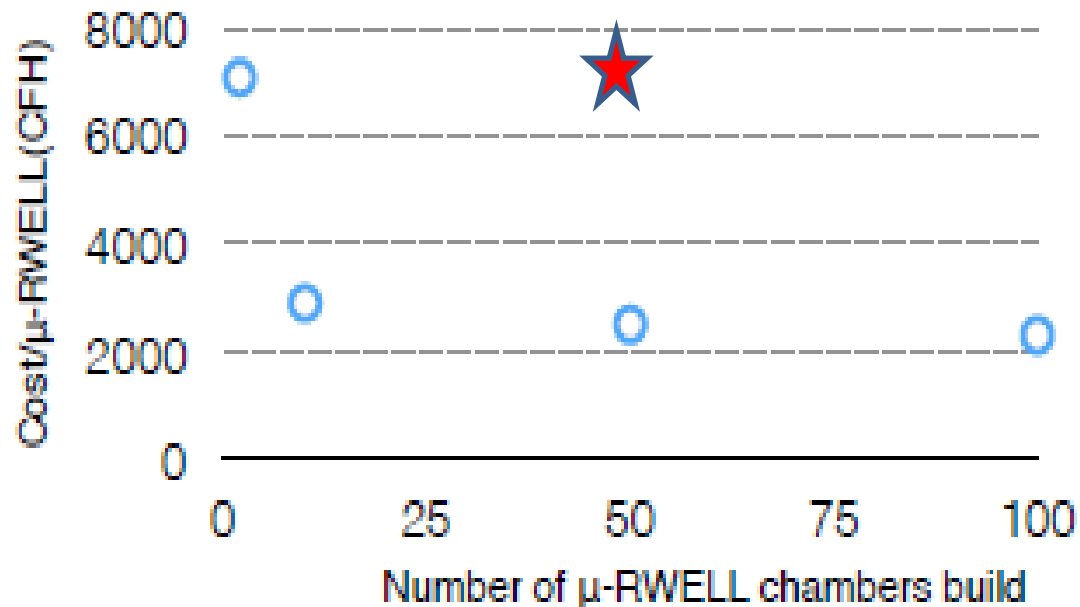
- compact
- simple to assemble & suitable for large size
- gas gain $\sim 10^4$
- intrinsically spark protected
- rate capability ~ 1 MHz/cm² for m.i.p
- space resolution $< 60\mu\text{m}$
- **work in progress:** *large area (CMS, SHIP); high rate with HR scheme (LHCb); larger gain with 125 μm thick WELL amplification stage (MPGD_NEXT) \rightarrow PHD position opening in Frascati Lab*

Spare slides

Cost of μ -RWELL and GEM for large volume production

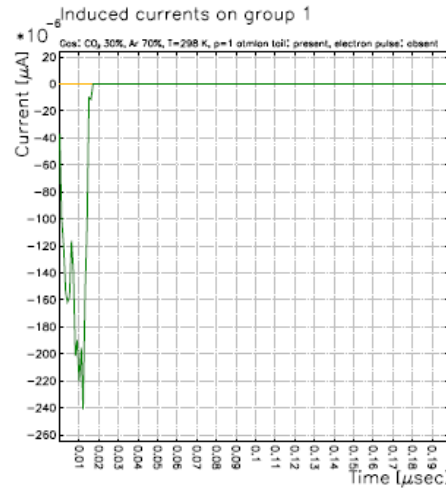
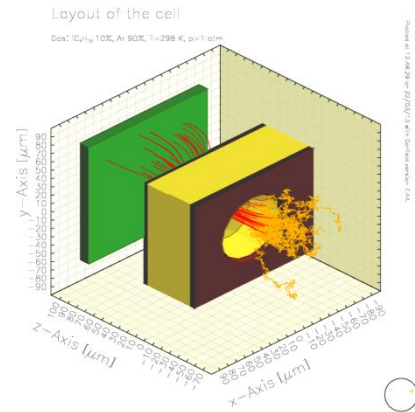
Open dots: cost estimate (by ELTOS SpA) of a $1.2 \times 0.5 \text{ m}^2$ μ -RWELL

Star: cost (by CERN) of a $1.2 \times 0.5 \text{ m}^2$ GEM

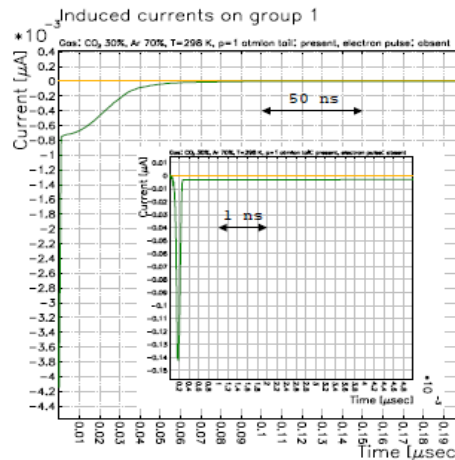
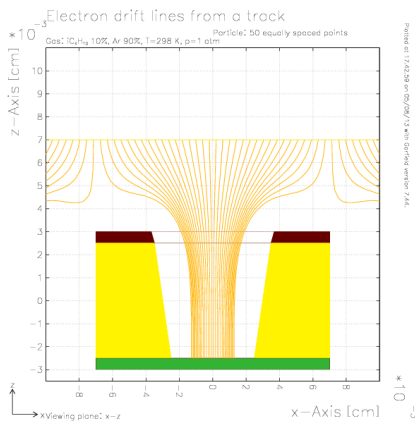


The μ -RWELL vs GEM (Garfield simulation)

GEM – Ar:CO₂ 70:30 gas mixture



Signal from a single ionization electron in a GEM.
The duration of the signal, about 20 ns, depends on the induction gap thickness, drift velocity and electric field in the gap.

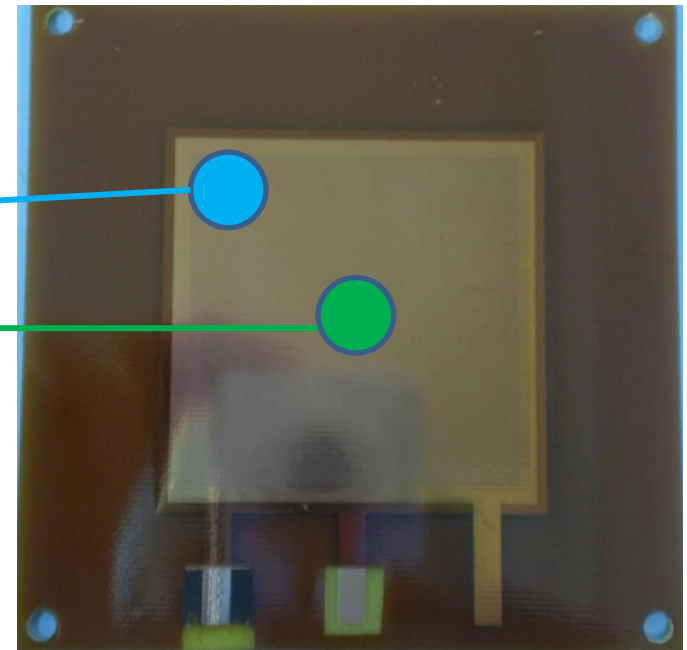
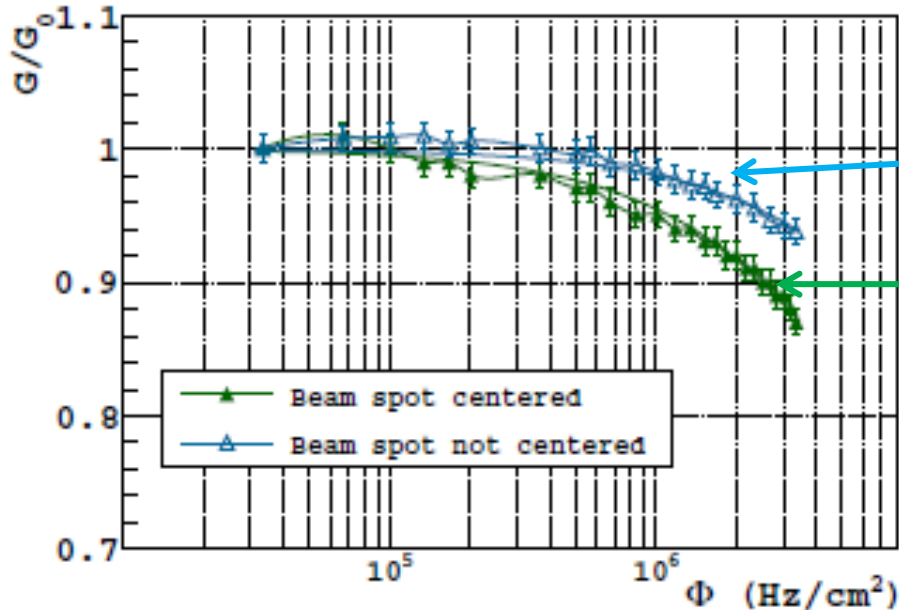


Signal from a single ionization electron in a μ -RWELL.
The absence of the induction gap is responsible for the fast initial spike, about 200 ps, induced by the motion and fast collection of the electrons and followed by a ~ 50 ns ion tail.

μ -RWELL – Ar:CO₂ 70:30 gas mixture

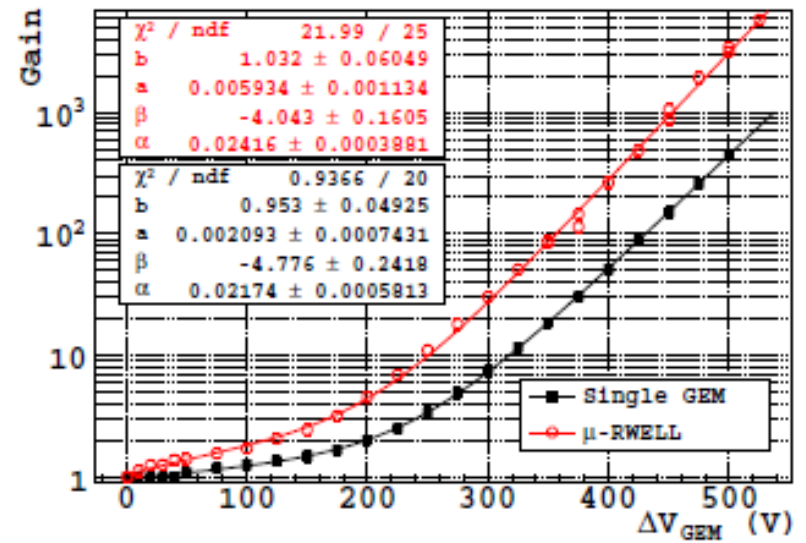
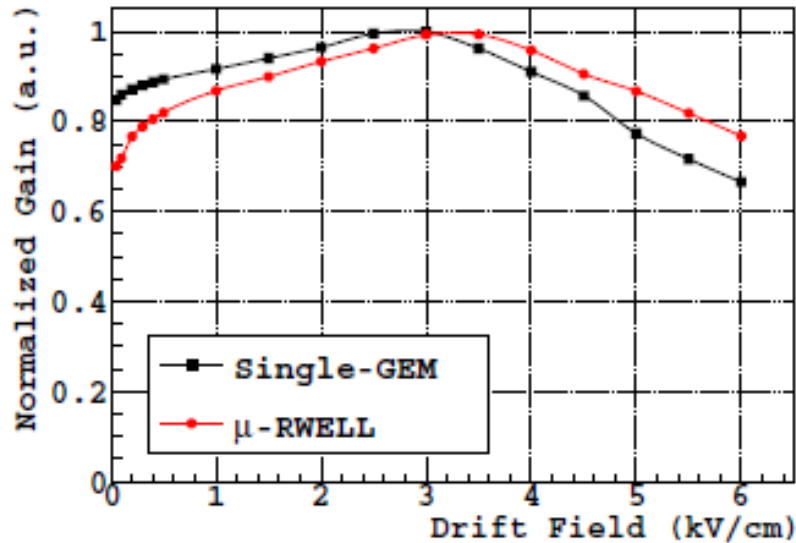
The μ -RWELL performance (VI)

Gain vs beam position



The gain (vs particle flux) depends on the beam position: the larger is the distance covered by electrons in the resistive layer (green curve) to reach the ground, the greater is the average resistance and the lower is the rate capability.

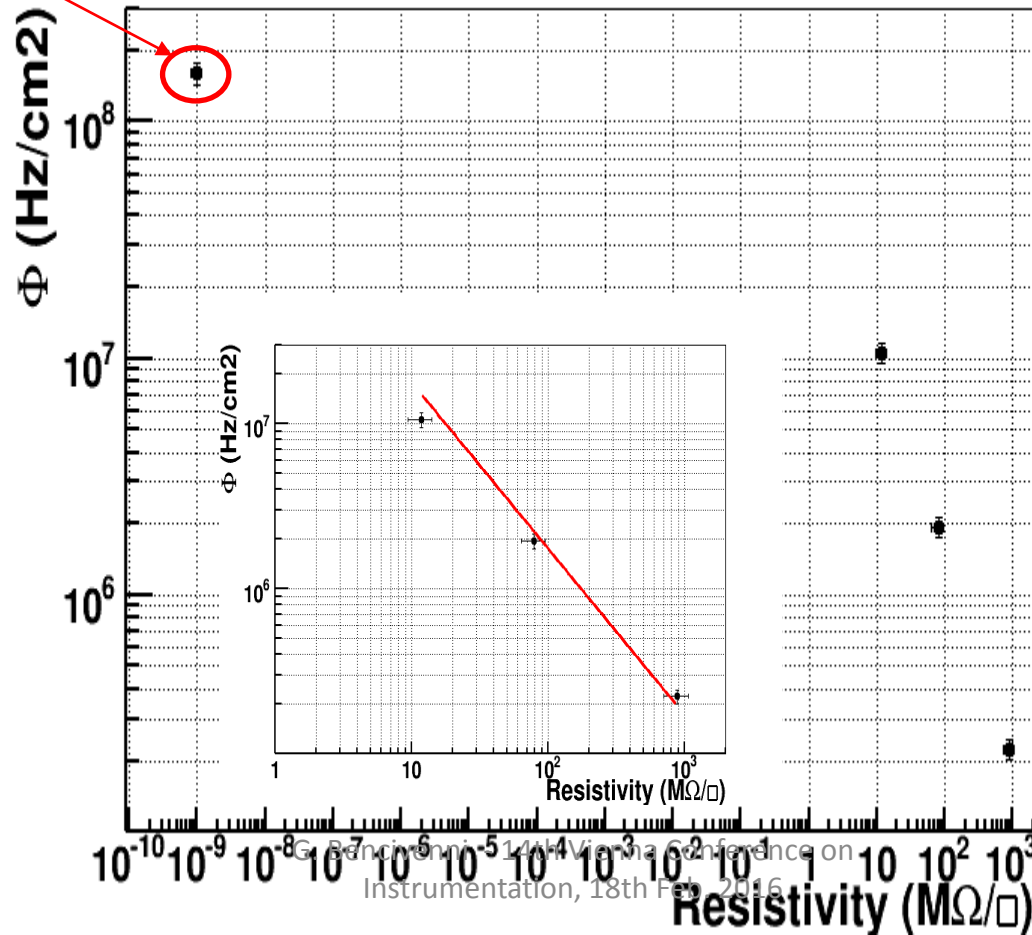
The prototype has been tested with Ar:CO₂ (70:30) gas mixture and characterized by measuring the gas gain, rate capability and discharge behavior in *current mode*.



μ -RWELL Rate Capability in Ar/ISO=90/10 with an X-Ray tube

Bellazini et al. NIMA 423 (1999) 125
Sauli et al., NIMA 419 (1998) 410.

Rate capability for $\Delta G = -3\%$
Ar/Iso=90/10 & X-ray



TB June 2015:

AR/CO2=70/30 vs AR/ISO=90/10

Rate Capability Ar/CO2 vs Ar/ISO

Ar/CO2 & $\rho = 100 \text{ M}\Omega/\square$

$\alpha = 0.024$

$N_0 = 209$ (Garfield simulation);

$G_0 = 2000$;

$\Omega = 600 \text{ M}\Omega$;

$r = 0.125 \text{ cm}$;

Ar/ISO & $\rho = 80 \text{ M}\Omega/\square$

$\alpha = 0.031$

$N_0 = 225$ (Garfield simulation);

$G_0 = 1000$;

$\Omega = 480 \text{ M}\Omega$ (estimated $\Omega = \rho_S \frac{d - \frac{r}{2}}{\pi r}$)

$r = 0.125 \text{ cm}$;

$$p_0 = \alpha e N_0 G_0 \Omega \pi r^2 = 5.6 \cdot 10^{-8}$$

$$p_0 = \alpha e N_0 G_0 \Omega \pi r^2 = 2.5 \cdot 10^{-8}$$

$$\frac{G}{G_0} = \frac{-1 + \sqrt{1 + 4p_0\Phi}}{2p_0\Phi} = 0,907 \quad (\Phi = 2 \text{ MHz/cm}^2)$$

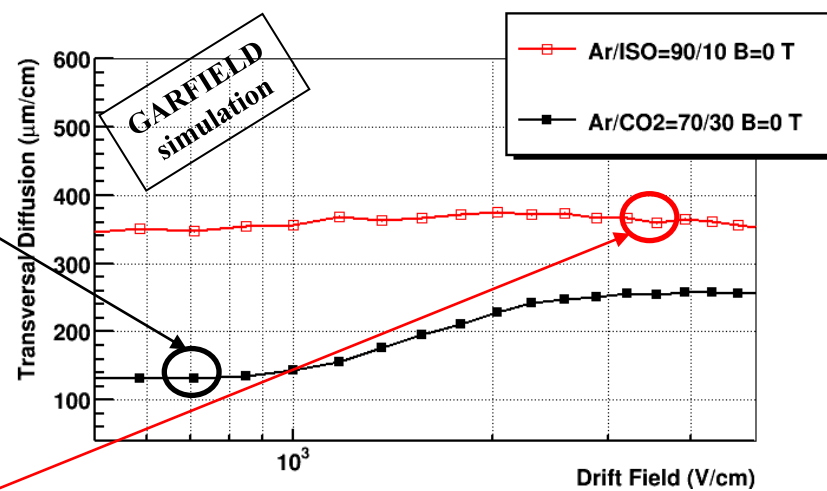
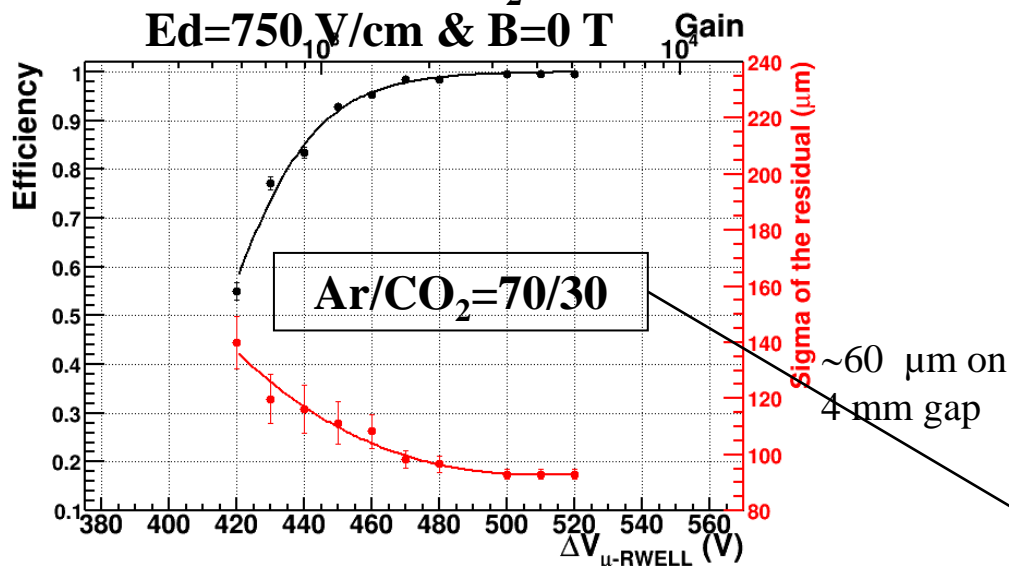
$$\frac{G}{G_0} = \frac{-1 + \sqrt{1 + 4p_0\Phi}}{2p_0\Phi} = 0,954 \quad (\Phi = 2 \text{ MHz/cm}^2)$$

TB June 2015 B=0T & $\theta=0^\circ$ Efficiency & Residual vs gas mixture

σ -Residual w/out TRK subtraction

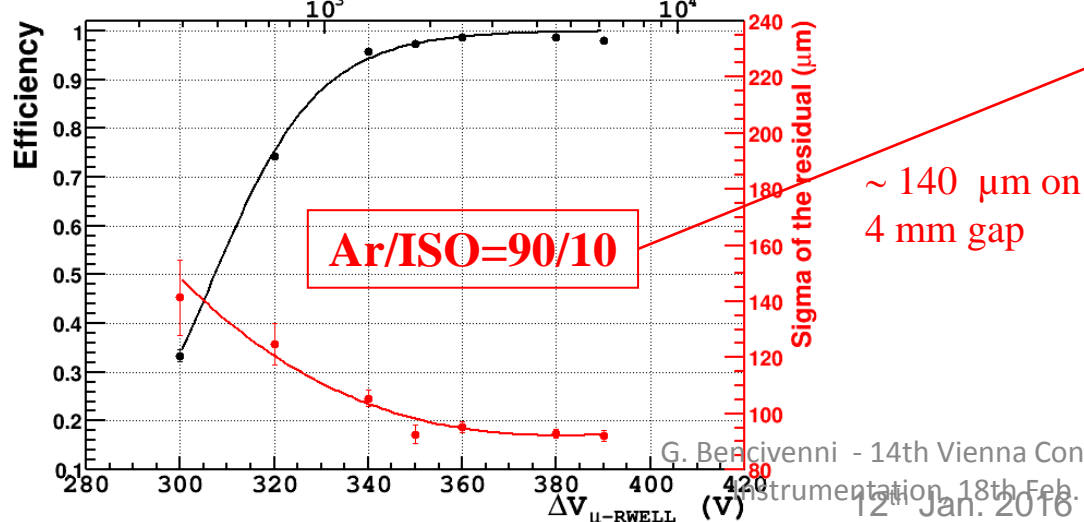
June 2015 – Ar/CO₂=70/30

Ed=750 V/cm & B=0 T



June 2015 – Ar/ISO=90/10

Ed=3.5 kV/cm & B=0 T



No large difference observed between Ar/CO₂ & Ar/ISO due to:

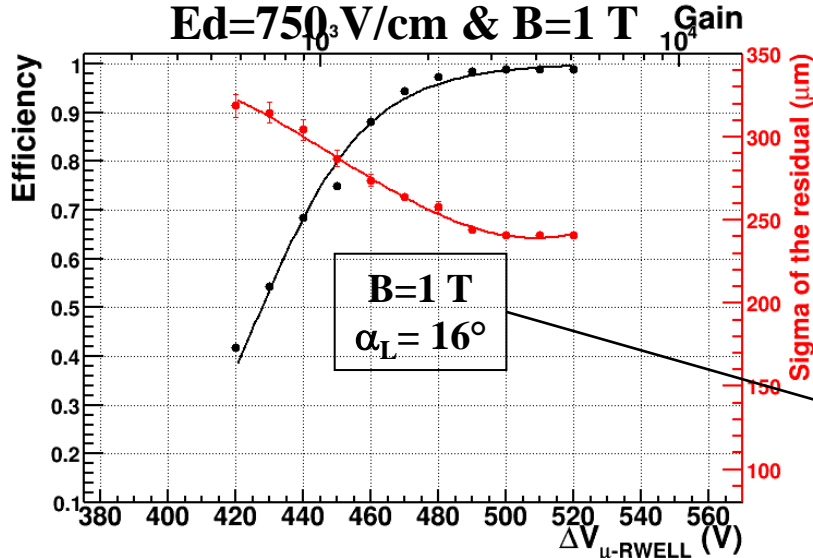
- μ -RWELL compactness
- relatively large strip pitch (400 μm)

TB June 2015, B=1T & $\theta=0^\circ$

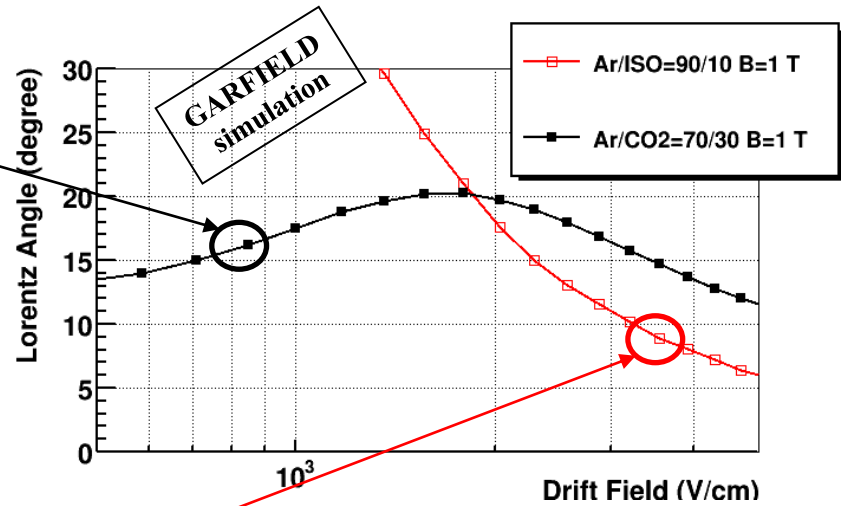
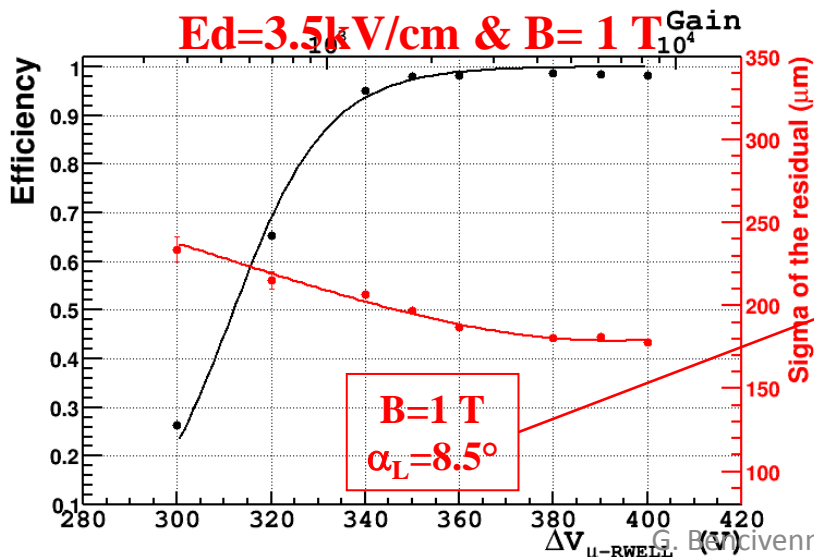
Efficiency & Residual vs gas mixture

σ -Residual w/out TRK subtraction

Ar/CO₂=70/30
Ed=750 V/cm & B=1 T

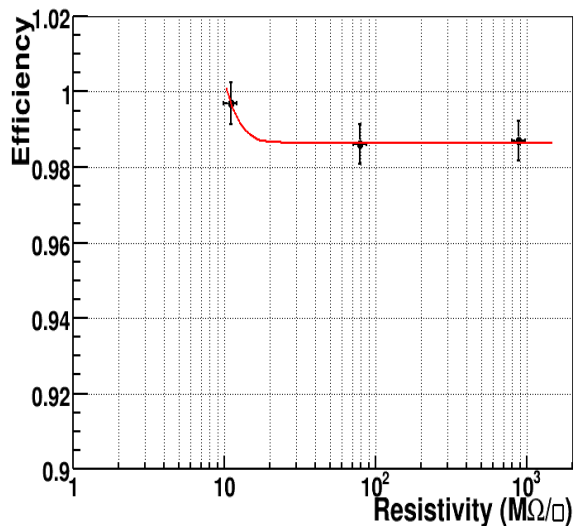


Ar/ISO=90/10
Ed=3.5k V/cm & B=1 T

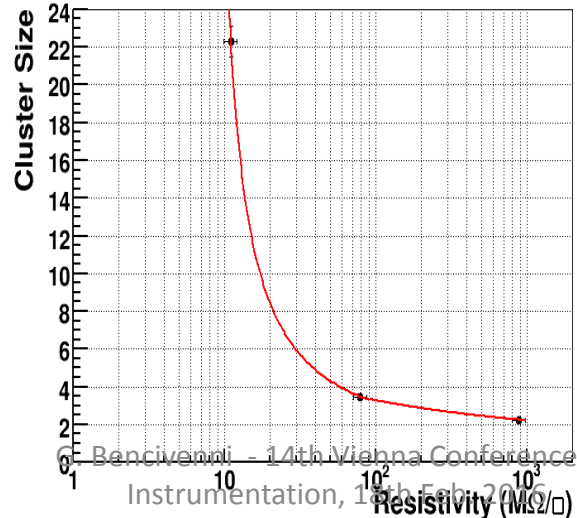
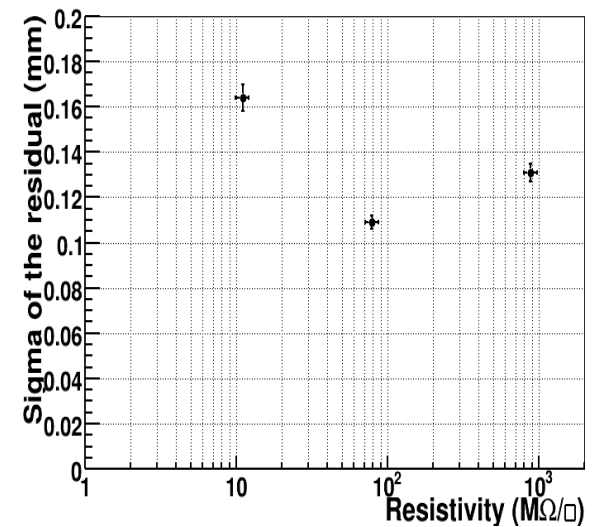


The difference on the residual is probably due to the diverse Lorentz angle

μ -RWELL Summary in Ar/ISO=90/10 @ SPS beam test

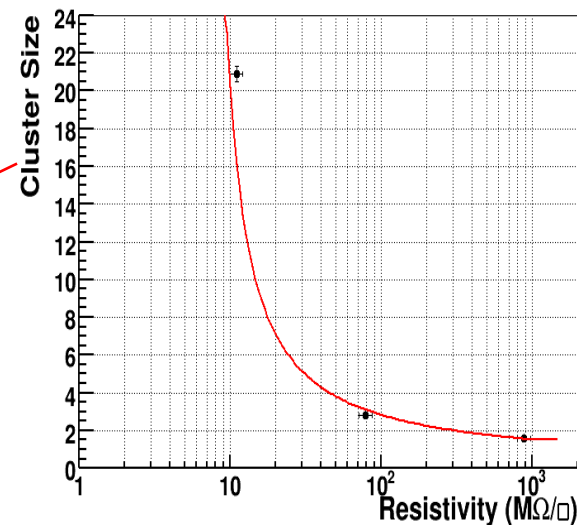
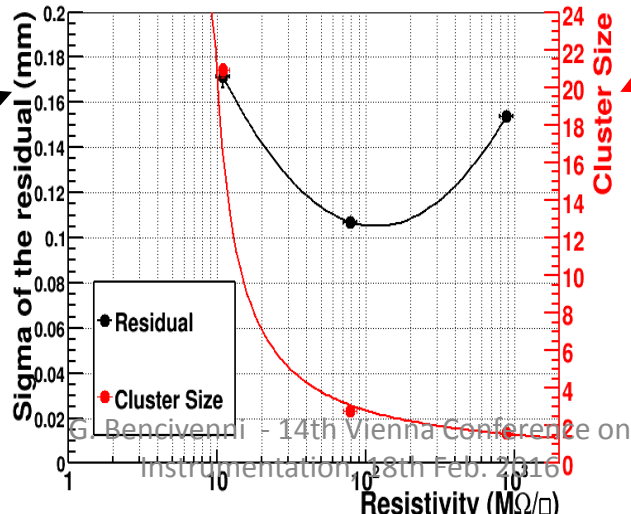
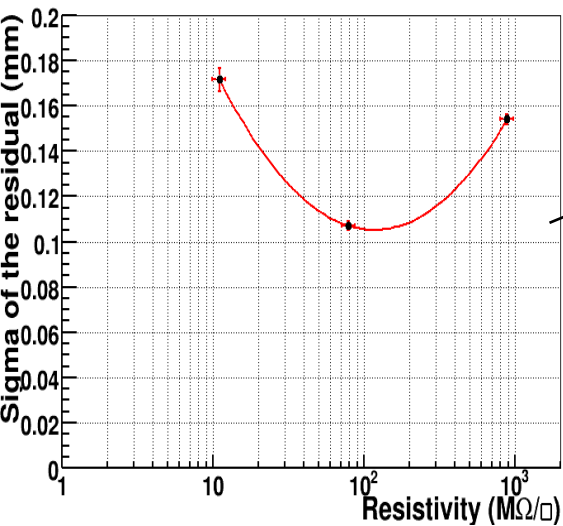
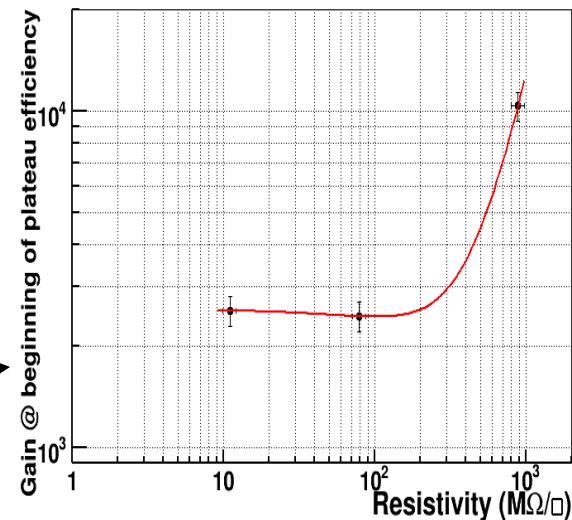


I punti nei plot presentati (efficienza, residui, clu size) sono riferiti al massimo valore del guadagno raggiunto per ogni rivelatore con mip



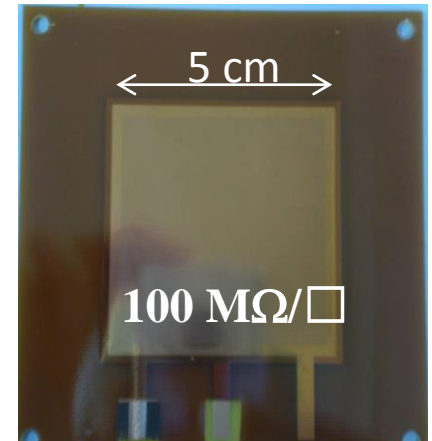
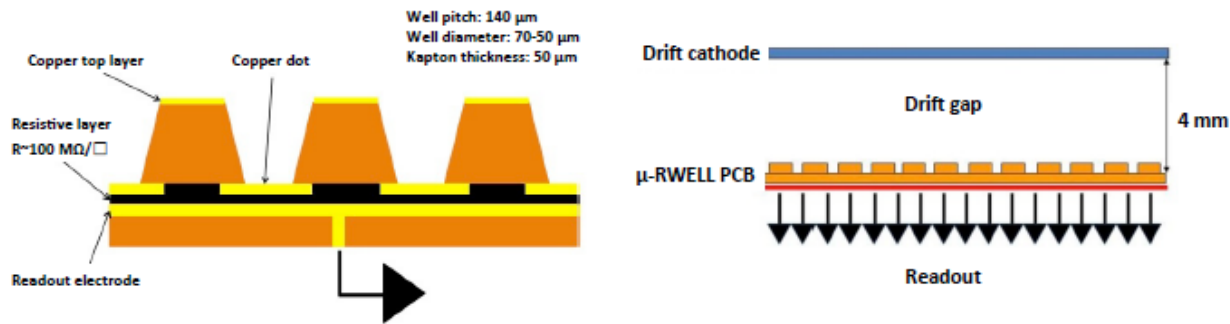
μ -RWELL Summary in Ar/ISO=90/10 @ SPS beam test

I punti nei plot presentati (residui, clu size) sono riferiti al guadagno a cui si raggiunge il plateau di efficienza per ogni prototipo



The μ -RWELL: a novel architecture (I)

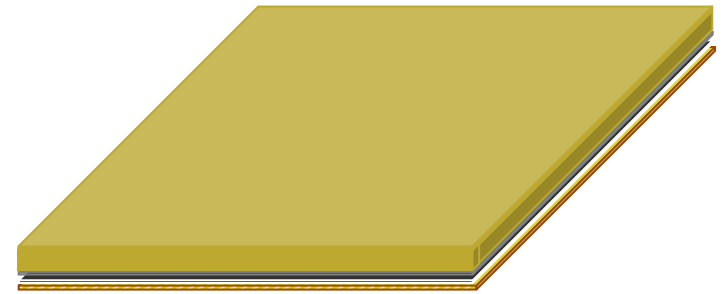
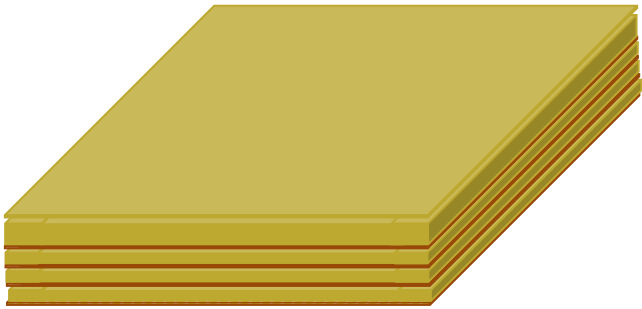
The goal of this study is the development of a novel MPGD by combining in a unique approach the solutions and improvements proposed in the last years in the MPGD field (RD51).



- The μ -RWELL is realized by coupling a “suitable patterned kapton foil” with the readout PCB plane through a resistive layer ($100 \text{ M}\Omega/\square$).
- The resistive coating is performed by screen printing or DLC \rightarrow robust against discharges.
- The WELL matrix is realized on a $50 \mu\text{m}$ thick polyimide foil, with conical channels $70\mu\text{m}$ ($50 \mu\text{m}$) top (bottom) diameter and $140\mu\text{m}$ pitch.
- A cathode electrode, defining the gas conversion/drift gap, completes the detector

\rightarrow compact & simple to build .
Go to page 12 with the conference proceedings
Instrumentation, 18th Feb. 2016

The μ -RWELL: a GEM-MM mixed solution



μ -RWELL

GEM detector sketch

MM detector sketch